FAIRCHILD

SEMICONDUCTOR TM

FQB7N60 / FQI7N60 600V N-Channel MOSFET

General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supply.

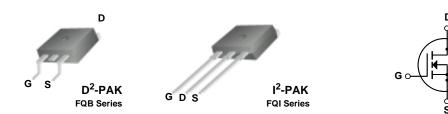
Features

- 7.4A, 600V, $R_{DS(on)} = 1.0\Omega @V_{GS} = 10 V$
- Low gate charge (typical 29 nC)
- Low Crss (typical 16 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- RoHS Compliant



October 2008

OFE]



Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Symbol	Parameter		FQB7N60 / FQI7N60	Units
V _{DSS}	Drain-Source Voltage		600	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$) - Continuous ($T_C = 100^{\circ}C$)		7.4	Α
			4.7	Α
I _{DM}	Drain Current - Pulsed	(Note 1)	29.6	Α
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		580	mJ
I _{AR}	Avalanche Current (Note 1)		7.4	Α
E _{AR}	Repetitive Avalanche Energy (Note 1		14.2	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		4.5	V/ns
P _D	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		3.13	W
	Power Dissipation ($T_C = 25^{\circ}C$)		142	W
- Derate above 25°C			1.14	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
Τ _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

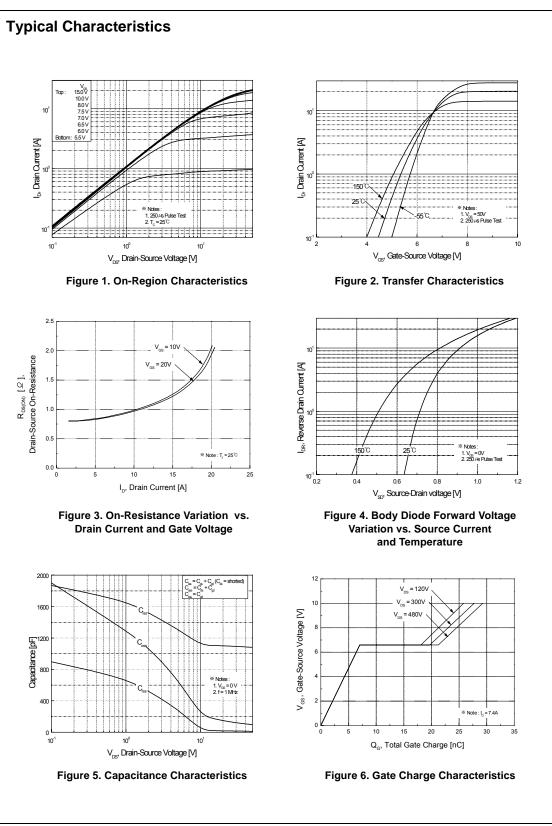
Thermal Characteristics

	0.88	°C/W
	0.00	C/ VV
	40	°C/W
	62.5	°C/W
_		

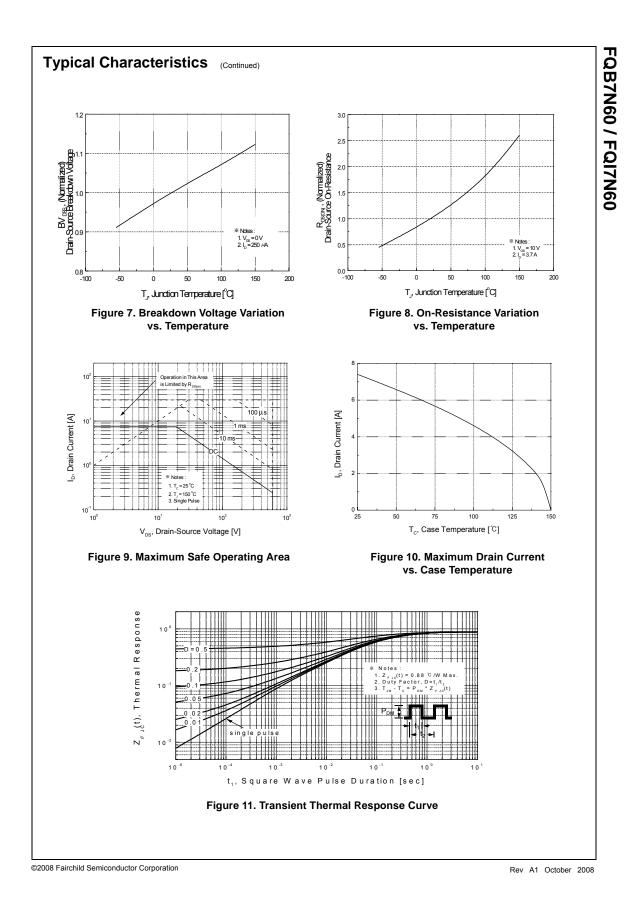
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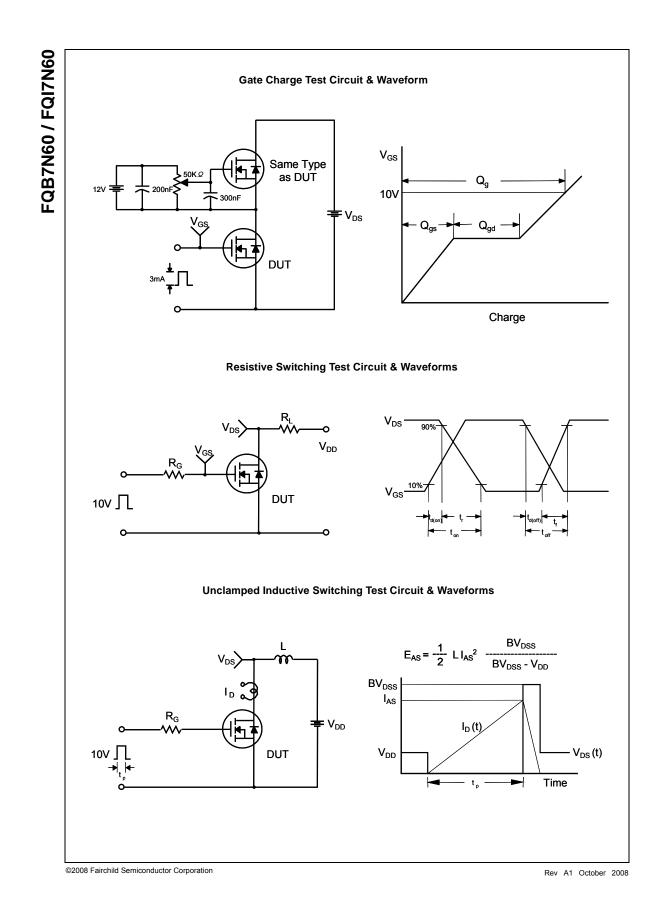
Symbol	Parameter	Test Conditions		Min	Тур	Max	Units
Off Cha	racteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA		600			V
ΔBV _{DSS}	•			000			v
ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to	25°C		0.67		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 600 V, V_{GS} = 0 V				10	μA
		V _{DS} = 480 V, T _C = 125°C				100	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 30 V, V_{DS} = 0 V				100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0 V				-100	nA
On Cha	racteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μ A		3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =3.7A			0.8	1.0	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 3.7 A (Note 4)		6.4		S
9F5					0.4		0
Dynami	c Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz			1100	1430	pF
C _{oss}	Output Capacitance				135	175	pF
C _{rss}	Reverse Transfer Capacitance				16	21	pF
t _{d(on)} t _r	Turn-On Delay Time Turn-On Rise Time Turn-Of Rise Time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 7.4 \text{ A},$ R _G = 25 Ω	-		30 80	70 170	ns ns
t _{d(off)}	Turn-Off Delay Time				65	140	ns
t _f	Turn-Off Fall Time	(N)	ote 4, 5)		60	130	ns
Qg	Total Gate Charge	V _{DS} = 480 V, I _D = 7.4 A,	_		29	38	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 10 V	-		7		nC
Q _{gd}	Gate-Drain Charge	(Ne	ote 4, 5)		14.5		nC
	ourse Diede Cheresterieties e	d Maximum Datinga					
	ource Diode Characteristics an Maximum Continuous Drain-Source Dio					7.4	А
I _S	Maximum Continuous Drain-Source Did Maximum Pulsed Drain-Source Diode F						
I _{SM} V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 7.4 A$				29.6 1.4	A V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 7.4 A,$			320		ns
0			Note 4)				пС
Repetitive Ra L = 19.5mH, $I_{SD} \le 7.4A, c$ Pulse Test : I	$\label{eq:response} \begin{array}{l} \mbox{Reverse Recovery Charge} \\ \mbox{ating : Pulse width limited by maximum junction temper } \\ \mbox{J}_{AS} = 7.4A, \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	rature	Note 4)		2.4		μC

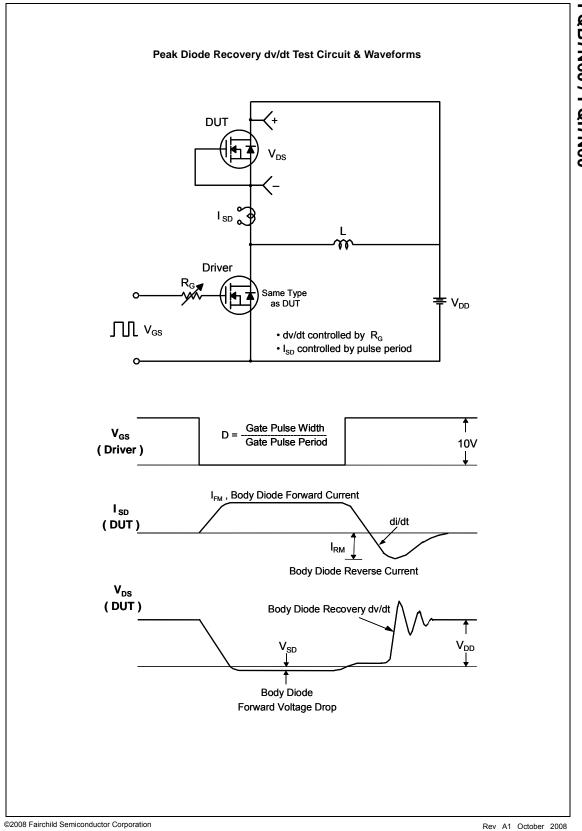
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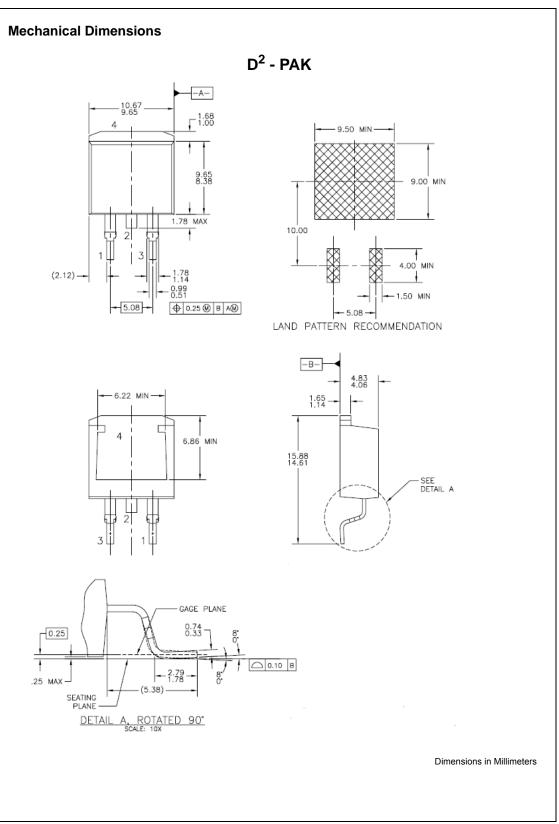
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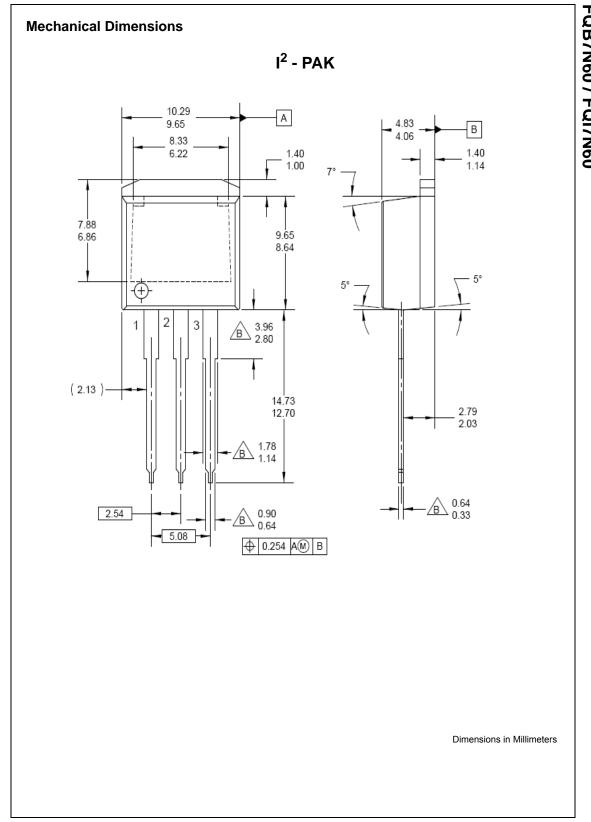




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